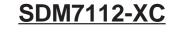
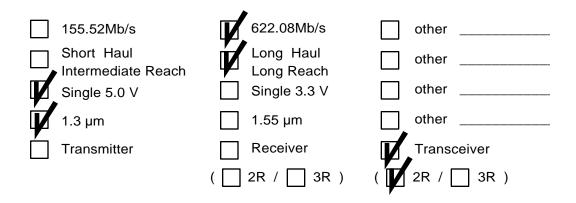
Specification : TS-S98D044A Date : March , 1999





# Technical Specification for Optical Transceiver Module







Sumitomo Electric reserves the right to make changes in this specification without prior notice.

#<u>Safety Precaution</u> Symbols This specification uses various picture symbols to prevent possible injury to operator or other persons or damage to properties for appropriate use of the product. The symbols and definitions are as shown below. Be sure to be familiar with these symbols before reading this specification.

<u> Marning</u>	Wrong operation without following this instruction may lead to human death or serious injury.					
▲ Caution	<b>Caution</b> Wrong operation without following this instruction may lead to human injury or property damage.					
Example of picture symbo	indicates prohibition of actions. Action details are explained thereafter.					
(SDM7112-XC)	indicates compulsory actions or instructions. Action details are explained thereafter $1/7$ -					

### 1. General

SDM7112-XC is a series of compact and high speed performance digital optical transceiver module ideally designed for versatile high speed network applications. 1300nm high speed InGaAsP DFB-LD and InGaAs PIN-PD are provided as a light source and a detector, respectively. Transceiver module has PC board mountable package with electrical and optical interfaces.

* Data Rate * Duty Cycle * Power Supply Voltage * Electrical Interface * Fiber Coupled Power * Sensitivity * Connector Interface	10 ~ 622.08Mbps, NRZ 50% Single +5.0V PECL -3dBm for SMF ~ -28dBm SC Duplex Connector
The features of SDM7112-XC a	
	Power Consumption Profile (9.8mm Max) Plastic Molded Package
	· · · · · · · · · · · · · · · · · · ·
	-sourced Footprint
Transmitter	Uncooled Laser with Automatic Power Control IC
	Class 1 Laser Product (IEC 825-1 and FDA 21 CFR 1040.10 and 1040.11)
Receiver	Wide Dynamic Range

Signal Detect (FLAG) Function

### 2. Block Diagram

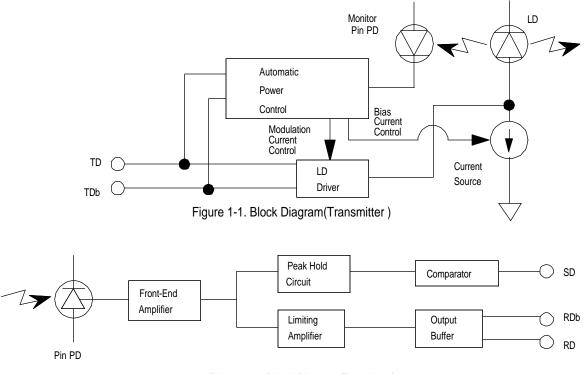


Figure 1-2. Block Diagram(Receiver)

Figure 3. Footprint

## 3. Package Dimension

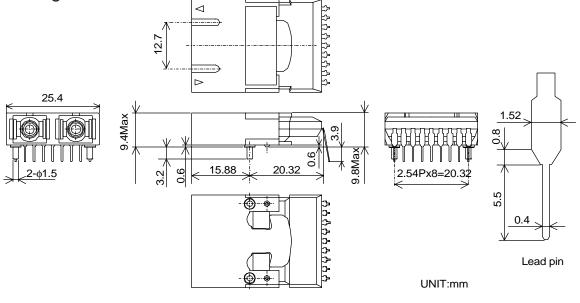


Figure 2. Package Dimension

	<u>∧</u> Caution
	$_{ m N}$ Do not disassemble this product. Otherwise, failure, electrical shock, overheating or fire may occur.
0	Handle the lead pins carefully. Use assisting tools or prospective aids as required. A lead pin may injure skin or human body

#### 4. Pin Assignment

4. PI	n Assign	ment	25.4
No.	Symbol	Function	20.32
1	Veerx	Power Supply (-) for Receiver : Connected to GND	
2	RD	Differential Data Output (Positive)	
3	RDb	Differential Data Output (Negative)	<u>2-φ1.9+/-0.1</u>
4	FLAG(SD)	FLAG (Signal Detect)	
5	Vccrx	Power Supply (+) for Receiver : Connected to +5.0V	[♥♦  ¥
6	Vcctx	Power Supply (+) for Transmitter : Connected to +5.0V	
7	TDb	Transmitter Differential Data (Negative)	50.33
8	TD	Transmitter Differential Data (Positive)	9-\u00f30.8+/-0.1
9	Veetx	Power Supply (-) for Transmitter : Connected to GND	

# 5. Absolute Maximum Ratings

Parameter	Symbol	min.	Max	Unit	Note
Storage Case Temperature	Ts	-40	85	°C	1
Operating Case Teperature	Tc	0	70	°C	1
Supply Voltage	Vcc-Vee	0.0	6.0	V	2
Input Voltage (TD, TDb)	Vi	0.0	Vcc	V	
Output Voltage (RD, RDb, SD)	lo		30	mA	
Lead Soldering (Temperature)	Ltemp		260	°C	3
Lead Soldering (Time)	Ltime		10	sec.	3

Note 1. No condensation allowed. 2. Vcc>Vee, Vcc=+5.0V, Vee=GND

3. Measured on lead pin at 2mm (0.079in.) off the package bottom

# \Lambda Warning

Use the product with the rated voltage described in the specification. If the voltage exceeds the maximum rating, overheating or fire may occur.

# ▲ Caution

Do not store the product in the area where temperature exceeds the maximum rating, where there is too much moisture or dampness, where there is acid gas or corrosive gas, or other extreme conditions. Otherwise, failure, overheating or fire may occur.

#### 6. Electrical Interface

(Unless otherwise specified, Vcc-Vee = 4.75 to 5.25 V and all operating temperature shall apply.)

#### 6-1. Transmitter side

Para	meter	Symbol	min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc-Vee	4.75	5.00	5.25	V	
Supply Current		ldtx		70	180	mA	1
Input Voltage	High	Vih	Vcc-1.17		Vcc-0.73	V	2
TD, TDb	Low	Vil	Vcc-1.95		Vcc-1.45		
Input Current	High	lih	-10		150	μA	2
TD, TDb	Low	lil	-10		10		
Signal Input Rise / F	all Time	Trin, Tfin			0.5	nsec.	3

Note 1. Input bias current is not included. 50% duty cycle data. 622.08Mbps 2. Vcc-Vee=5.0V, Tc=25°C 3. 20 ~ 80%

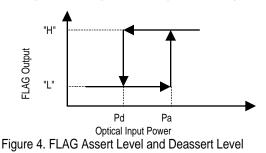
#### 6-2. Receiver side

Parame	eter	Symbol	min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc-Vee	4.75	5.00	5.25	V	
Supply Current		Idrx		60	120	mA	1
Data & SD	High	Voh	Vcc-1.03		Vcc-0.88	V	2
Output Voltage	Low	Vol	Vcc-1.81		Vcc-1.62		
Data Rise / Fall Time o	f Output Signal	Trout, Tfout		0.5		nsec	3

Note 1. Output current is not included.

2. Vccrx=+5.0V, Tc=25°C, Output load resistance

3.20 ~ 80%



# 7. Optical Interface

(Unless otherwise specified, Vcc-Vee = 4.75 to 5.25 V and all operating temperature shall apply.)

#### 7-1. Transmitter side

Parameter	Symbol	min.	Тур.	Max.	Unit	Note
Average Output Power to SMF	Pos	-3.0		2.0	dBm	1
Extinction Ratio	Er	10.0			dB	1
Center Wavelength	λς	1280		1335	nm	
Spectral Width (RMS)	Δλ			1.0	nm	
Side Mode Suppression Raito	Sr	30.0			dB	
Eye Mask for Optical Output	Refer to Figure 5			•		

Note 1. Measured at 622.08Mbps PRBS2^23-1, 50% duty cycle data

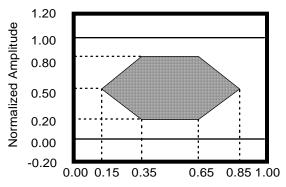


Figure 5. Optical Pulse Mask with Fourth Order Bessel-Thomson Filter Specified in ITU-T G.957

Relation between Input Signal and Optical Output Signal

and Optical V	Julpul Signal	
Input S	ignal	Optical Output Signal
TD	TDb	
High	Low	ON (High)
Low	High	OFF (Low)
High	High	Undefined
Low	Low	Undefined

# 🛦 Warning Do not look at the laser beam projection area (e.g. end of optical connector) with naked eyes or through optical equipment while the power is supplied to this product. Otherwise, your eyes may be injured.

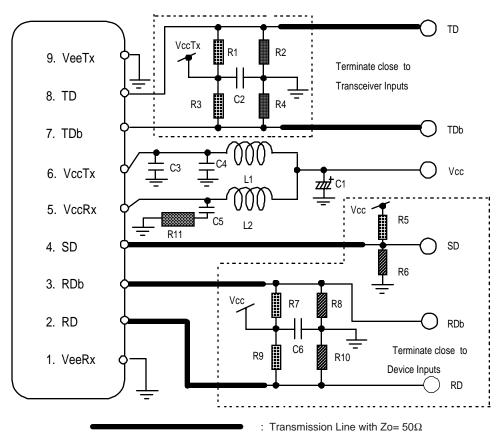
 $<sup>\</sup>text{RI=}50\Omega$  to Vccrx-2V for RD, RDb and SD.

#### 7-2. Receiver side

Parameter	Symbol	min.	Тур.	Max.	Unit	Note
Average Input Power to SMF	Pin	-28.0		-8.0	dBm	1, 2
Flag Assert Level	Pa	-48.0	-31.0	-28.0	dBm	2
Flag deassert Level	Pd	-49.0	-34.0	-28.0	dBm	2
Flag Assert Time	Tsda			100	μsec	2, 3
Flag deassert Time	Tsdd			350	μsec	2, 3

Note 1. BER=10^-10, 2. Measured at the bit rate of 622.08Mbps, PRBS 2/23-1, NRZ 3. 50% duty cycle data

# 8. Recommended Inteface Circuit



 $\begin{array}{l} R1=R3=R5=R7=R9=82\Omega\ ,\ R2=R4=R6=R8=R10=130\Omega\ ,\ R11=10\Omega\\ C1=100\ \mu F,\ C3=2200\ pF,\ C2=C6=0.1\ \mu F,\ C4=C5=1\ \mu F\\ L1,\ L2:\ Ferrite\ Bead\ \ ZBF\ 253D-00\ (TDK) \end{array}$ 

Figure 6 Recommended Interface Circuit

# 9. Reliability Test

Heading	Test	Reference	Condition	Samplir	ng		SEI P	lan
Ū				LTPD	SS	С	SS	F/C
Mechanical	Mechanical	MIL-STD-883	Condition B					
Integrity	Shock	Method 2002	5 times/axis					
• •			500G, 1.0 ms	20%	11	0		
			1,500G, 0.5ms	20%	11	0	11	0
	Vibration	MIL-STD-883	Condition A	20%	11	0	11	0
		Method 2007	20 G					
			20-2,000 Hz					
			4 min/cycle; 4 cycles/axis					
	Thermal Shock	MIL-STD-883	ΔT=100°C	20%	11	0	11	0
		Method 1011						
	Solderability	MIL-STD-883	(steam aging not required)	20%	11	0	11	0
		Method 2003						
	Fiber Pull		1 Kg; 3 times;5sec.	20%	11	0		
			2 Kg; 3 times; 5sec.	20%	11	0		
Endurance	Accel. Aging	(R)-453	+85C; rated power					
	(High Temp.)	Section 5.18	>5,000hrs.		25		25	0
			>10,000hrs.		10			
	High Temp.		max. storage T (T=85°C)	20%	11	0		
	Storage		>2,000					
	Low Temp.		min. storage T (T=-40°C)	20%	11	0	11	0
	Storage		>2,000					
	Temperature	Section 5.20	- 40°C to +85°C					
	Cycling		400 times pass/fail	20%	11	0		
			500 times for info.		11			
			500 times pass/fail	20%	11	0	11	0
			1000 times for info.		11		11	0
	Damp Heat	MIL-STD-202 M103	40°C , 95%, 56days	20%	11	0	11	0
	(if using epoxy)	or IEC 68-2-3	or 85°C /85%RH 2,000hrs.	20%	11	0		
	Cyclic Moisture	Section 5.23		20%	11	0	11	0
	Resistance							
Special	Internal	MIL-STD-883	< 5,000 ppm	20%	11	0	11	0
Tests	Moisture	Method 1018	water vapor					
	Flammability	TR357:Sec. 4.4.2.5						OK
	ESD Threshold	Section 5.22			6		6	0

# 10. Laser Safety

This product uses a semiconductor laser system and is a laser class 1 product acc. FDA, complies with 21CFR1040. 10 and 1040.11. Also this product is a laser class 1 product acc. IEC 825-1.

Class 1 Laser Product

▲Caution

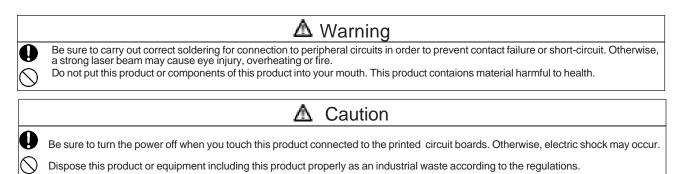
Solution of this product is used under conditions not recommended in the specification or this product is used with unauthorized revision, classification for laser product safety standard is invalid. Classify the product again at your responsibility and take appropriate actions.

### 11. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

This module must be handled, used and disposed of according to your company's safe working practice.



## 12. Ordering Information

Ordering Number	Connector type	Operating Temparature
SDM7112-XC	SC Duplex Connector	Tc = 0 ~ 70°C

### 13. For More Information

<u>U.S.A.</u>

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<u>Japan</u>

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